# Common Mode Filter with ESD Protection

#### **Functional Description**

The EMI814x is a family of Common Mode Filters (CMF) with integrated ESD protection, a first in the industry. Differential signaling I/Os can now have both common mode filtering and ESD protection in one package. The EMI814x protects against ESD pulses up to  $\pm 15$  kV contact per the IEC61000–4–2 standard.

The EMI814x is well-suited for protecting systems using high-speed differential ports such as USB 3.0, MIPI D-PHY; corresponding ports in removable storage, and other applications where ESD protection are required in a small footprint package.

The EMI814x is available in a RoHS-compliant, XDFN6 for 1 Differential Pair, XDFN-10 for 2 Differential Pair and XDFN-16 package for 3 Differential Pair.

#### Features

- Total Insertion Loss  $DM_{LOSS} < 2.5 \text{ dB}$  at 2.5 GHz
- Large Differential Mode Cutoff Frequency  $f_{3dB} > 5$  GHz
- High Common Mode Stop Band Attenuation: > 10 dB at 500 MHz , 15 dB at 700 MHz
- Low Channel Resistance 6.0  $\Omega$
- Provides ESD Protection to IEC61000-4-2 Level 4, ±15 kV Contact
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

#### Applications

- USB 3.0
- MHL 2.0
- µSD Card
- eSATA
- HDMI/DVI Display in Mobile Phones
- MIPI D–PHY (CSI–2, DSI, etc) in Mobile Phones and Digital Still Cameras

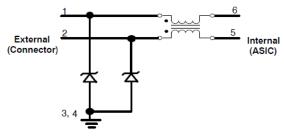
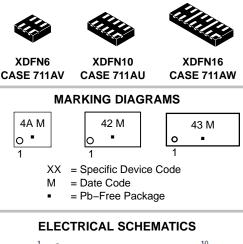


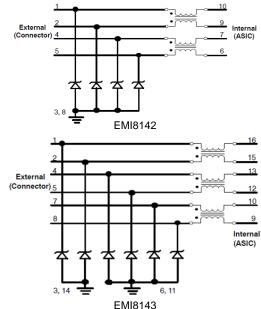
Figure 1. EMI8141 Electrical Schematic



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#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>	
EMI8141MUTAG	XDFN6	3000 / Tape & Reel	
EMI8142MUTAG	XDFN10	3000 / Tape & Reel	
EMI8143MUTAG	XDFN16	3000 / Tape & Reel	

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### PIN FUNCTION DESCRIPTION

		Device Pin			
Pin Name	EMI8141	EMI8142	EMI8143	Туре	Description
ln_1+	1	1	1	I/O	CMF Channel 1+ to Connector (External)
ln_1-	2	2	2	I/O	CMF Channel 1– to Connector (External)
Out_1+	6	10	16	I/O	CMF Channel 1+ to ASIC (Internal)
Out_1-	5	9	15	I/O	CMF Channel 1– to ASIC (Internal)
ln_2+	NA	4	4	I/O	CMF Channel 2+ to Connector (External)
ln_2-	NA	5	5	I/O	CMF Channel 2– to Connector (External)
Out_2+	NA	7	13	I/O	CMF Channel 2+ to ASIC (Internal)
Out_2-	NA	6	12	I/O	CMF Channel 2– to ASIC (Internal)
In_3+	NA	NA	7	I/O	CMF Channel 3+ to Connector (External)
ln_3–	NA	NA	8	I/O	CMF Channel 3– to Connector (External)
Out_3+	NA	NA	10	I/O	CMF Channel 3+ to ASIC (Internal)
Out_3-	NA	NA	9	I/O	CMF Channel 3– to ASIC (Internal)
VN	3,4	3, 8	3,6,14,11	GND	Ground

#### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Operating Temperature Range	T <sub>OP</sub>	-40 to +85	°C
Storage Temperature Range	T <sub>STG</sub>	-65 to +150	°C
Maximum Lead Temperature for Soldering Purposes (1/8" from Case for 10 seconds)	ΤL	260	°C
DC Current per Line	I <sub>LINE</sub>	100	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted)

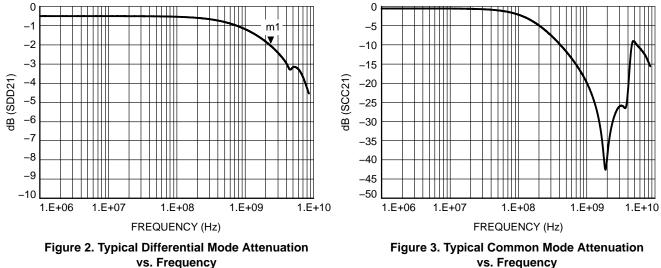
Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
V <sub>RWM</sub>	Reverse Working Voltage	(Note 3)		3.3		V
$V_{BR}$	Breakdown Voltage	I <sub>T</sub> = 1 mA; (Note 4)	4.0		9.0	V
I <sub>LEAK</sub>	Channel Leakage Current	$T_A = 25^{\circ}C, V_{IN} = 3.3 V, GND = 0 V$			1.0	μΑ
R <sub>CH</sub>	Channel Resistance (Pins 1–6, 2–5) – EMI8141 (Pins 1–10, 2–9, 4–7 and 5–6) – EMI8142 (Pins 1–16, 2–15, 4–13, 5–12, 7–10 and 8–9) – EMI8143			6.0		Ω
DMLOSS	Differential Mode Insertion Loss	@ 2.5 GHz		2.5		dB
f <sub>3dB</sub>	Differential Mode Cut-off Frequency	50 $\Omega$ Source and Load Termination		5.0		GHz
F <sub>atten</sub>	Common Mode Stop Band Attenuation	@ 700 MHz		15		dB
V <sub>ESD</sub>	In-system ESD Withstand Voltage a) Contact discharge per IEC 61000-4-2 standard, Level 4 (External Pins) b) Contact discharge per IEC 61000-4-2 standard, Level 1 (Internal Pins)	(Notes 1 and 2)	±15 ±2			kV
V <sub>CL</sub>	TLP Clamping Voltage	Forward $I_{PP} = 8 A$ Forward $I_{PP} = 16 A$ Forward $I_{PP} = -8 A$ Forward $I_{PP} = -16 A$		7.26 11.8 -3.5 -6.7		V

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product

 Standard IEC61000-4-2 with C<sub>Discharge</sub> = 150 pF, R<sub>Discharge</sub> = 330, GND grounded.
 These measurements performed with no external capacitor.
 TVS devices are normally selected according to the working peak reverse voltage (V<sub>RWM</sub>), which should be equal to or greater than the DC or caption peak on peak peak reverse voltage (V<sub>RWM</sub>). or continuous peak operating voltage level.

4.  $V_{BR}$  is measured at pulse test current I<sub>T</sub>.

#### **TYPICAL CHARACTERISTICS**



vs. Frequency

Interface	Data Rate (Gb/s)	Fundamental Frequency (GHz)	ESD814x Insertion Loss (dB)
USB 3.0	5	2.5 (m1)	m1 = 2.13

#### TRANSMISSION LINE PULSE (TLP) MEASUREMENTS

Transmission Line Pulse (TLP) provides current versus voltage (I–V) curves in which each data point is obtained from a 100 ns long rectangular pulse from a charged transmission line. A simplified schematic of a typical TLP system is shown in Figure 4. TLP I–V curves of ESD protection devices accurately demonstrate the product's ESD capability because the 10 s of amps current levels and under 100 ns time scale match those of an ESD event. This is illustrated in Figure 5 where an 8 kV IEC61000–4–2 current waveform is compared with TLP current pulses at 8 A and 16 A. A TLP curve shows the voltage at which the device turns on as well as how well the device clamps voltage over a range of current levels. Typical TLP I–V curves for the EMI814x are shown in Figure 4.

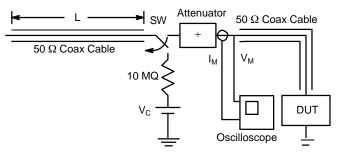


Figure 4. Simplified Schematic of a Typical TLP System

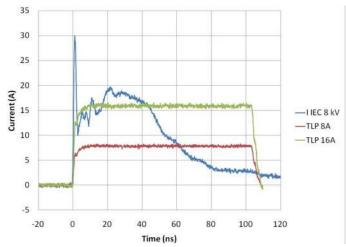
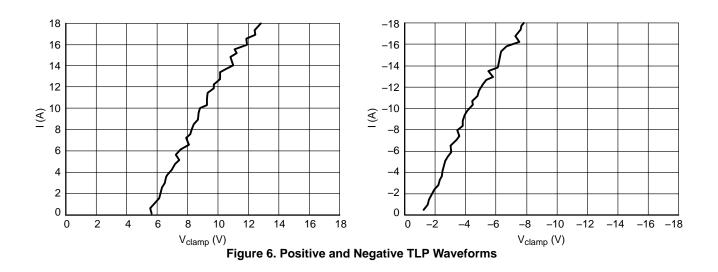


Figure 5. Comparison Between 8 kV IEC61000-4-2 and 8 A and 16 A TLP Waveforms



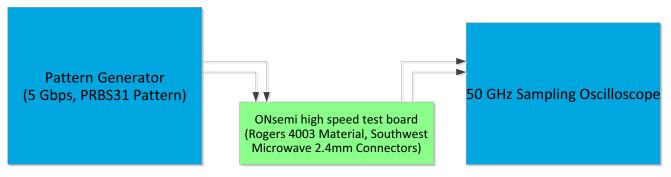


Figure 7. Eye Diagram Test Setup for 5Gbps Data Rate

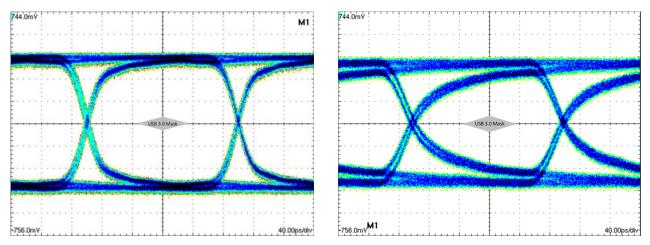
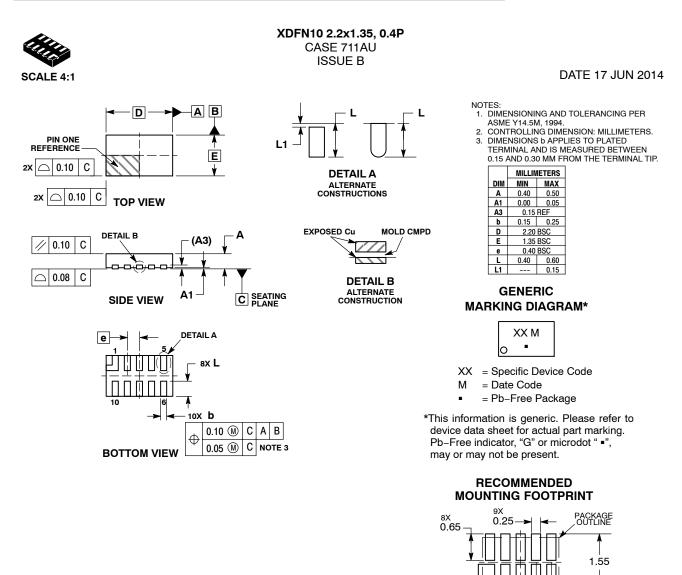


Figure 8. Eye Diagram 5Gbps with and without EMI814x

	Eye Height (mVppd)	Rise Time (ps)	Fall Time (ps)	Jrms (ps)	Jpp (ps)
Reference (No Device)-Left Figure	724	30.4	29.6	1.997	9.6
EMI814x Right Figure	405	60	60.8	3.484	16





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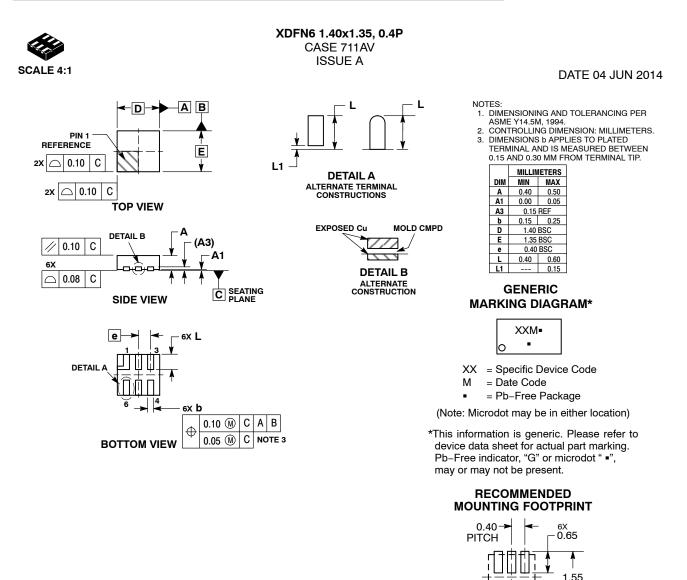
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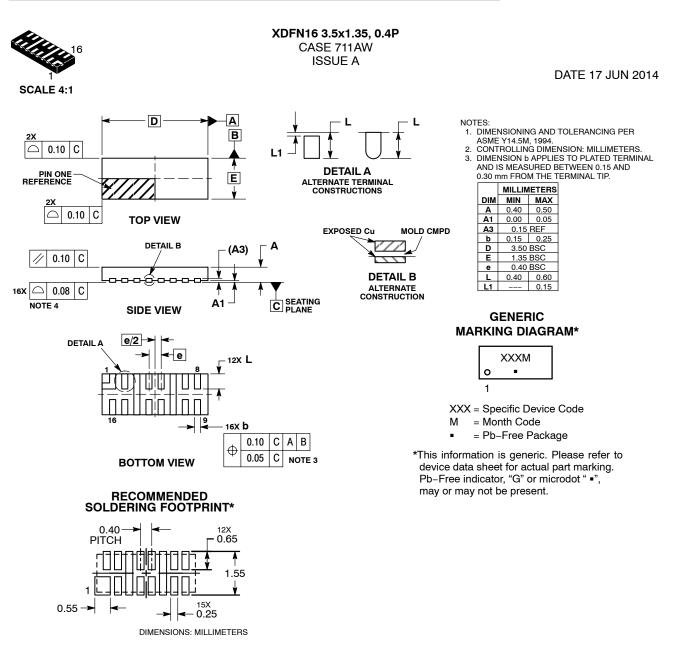
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\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

 
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